<u>MOSFET</u> – Power, Single N-Channel 60 V, 1.36 mΩ, 250 A

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C612NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

	(1) = 20				-	
Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			V _{DSS}	60	V	
Gate-to-Source Voltage	e		V _{GS}	±20	V	
Continuous Drain		$T_C = 25^{\circ}C$	I _D	250	А	
Current R _{θJC} (Notes 1, 3)	Steady	T _C = 100°C		175		
Power Dissipation	State	T _C = 25°C	PD	167	W	
$R_{\theta JC}$ (Note 1)		T _C = 100°C		83		
Continuous Drain	Steady State	$T_A = 25^{\circ}C$	۱ _D	38	А	
Current R _{θJA} (Notes 1, 2, 3)		T _A = 100°C		27	1	
Power Dissipation		T _A = 25°C	PD	3.8	W	
$R_{\theta JA}$ (Notes 1 & 2)		T _A = 100°C		1.9	1	
Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	I _{DM}	900	А	
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to +175	°C	
Source Current (Body Diode)			IS	164	А	
Single Pulse Drain-to-Source Avalanche Energy ($I_{L(pk)} = 17 A$)			E _{AS}	451	mJ	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C	

MAXIMUM RATINGS (T = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	0.9	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	39	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

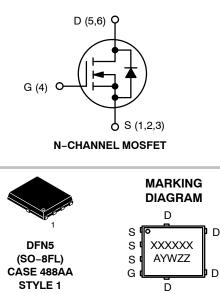
3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
60 V	1.36 m Ω @ 10 V	250 A
00 V	2.3 mΩ @ 4.5 V	250 A





ORDERING INFORMATION

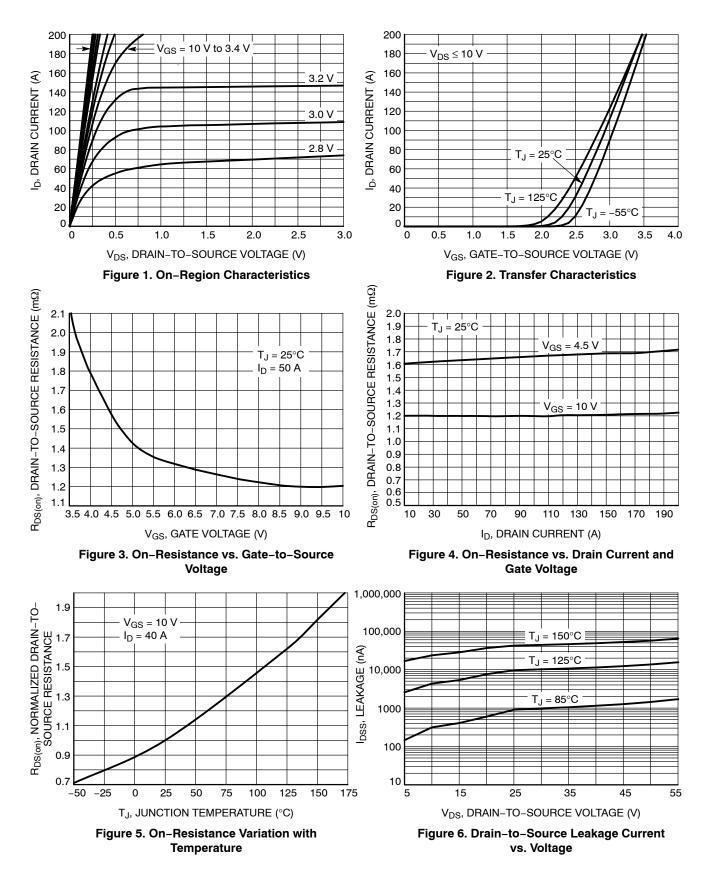
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

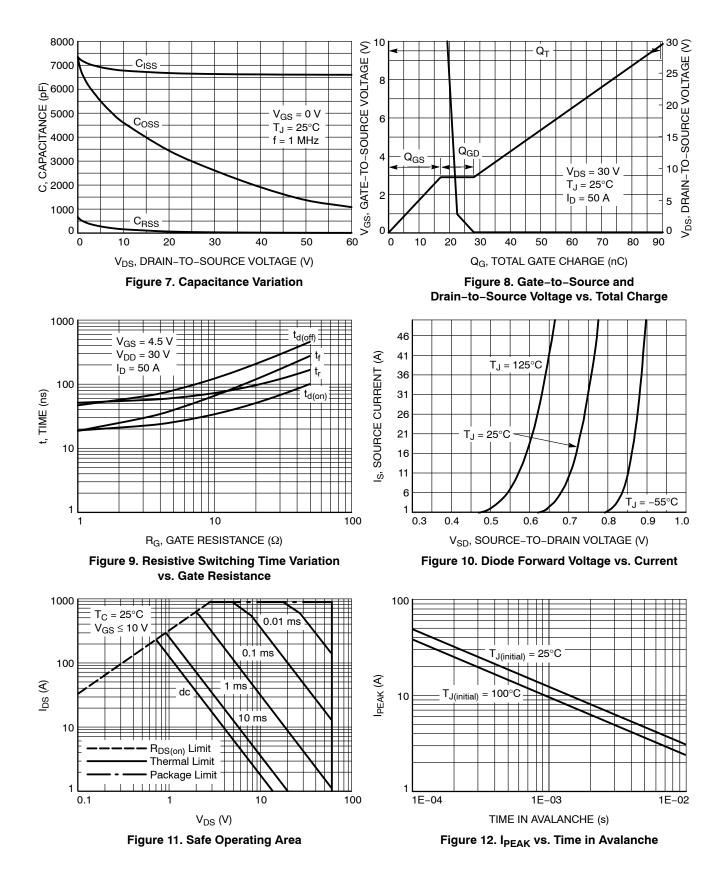
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS					•		
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				12.7		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	T _J = 25 °C			10	
		$V_{DS} = 60 V$	T _J = 125°C			250	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±16 V				±100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	V_{GS} = V_{DS} , I_D = 250 μ A		1.2		2.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.76		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 50 A		1.13	1.36	
		V _{GS} = 4.5 V	I _D = 50 A		1.65	2.3	mΩ
Forward Transconductance	9 _{FS}	V _{DS} = 15 V, I _D = 50 A			151		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE						
Input Capacitance	C _{ISS}				6660		
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			2953		pF
Reverse Transfer Capacitance	C _{RSS}				45		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 4.5 V, V_{DS} = 30 V; I_{D} = 50 A			41		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 30 V; I_{D} = 50 A			91		
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _{DS} = 30 V; I _D = 50 A			5		nC
Gate-to-Source Charge	Q _{GS}				17.1		
Gate-to-Drain Charge	Q _{GD}				10.9		
Plateau Voltage	V _{GP}				2.9		V
SWITCHING CHARACTERISTICS (Note 5	5)			-			-
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V_{DS} = 30 V, I _D = 50 A, R _G = 1.0 Ω			19		ns
Rise Time	tr				51		
Turn-Off Delay Time	t _{d(OFF)}				47		
Fall Time	t _f				18		
DRAIN-SOURCE DIODE CHARACTERIS	TICS				•		
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V, T_{J} = 25^{\circ}C T_{J} = 125^{\circ}C T_{J} = 125^{\circ}C$	$T_J = 25^{\circ}C$		0.78	1.2	
			T _J = 125°C		0.66		V
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/µs, I _S = 50 A			78		
Charge Time	t _a				36		ns
Discharge Time	t _b				42		
Reverse Recovery Charge	Q _{RR}				105		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



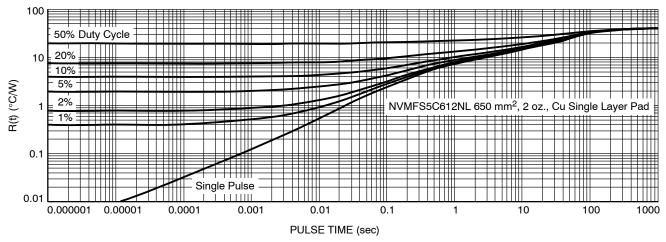


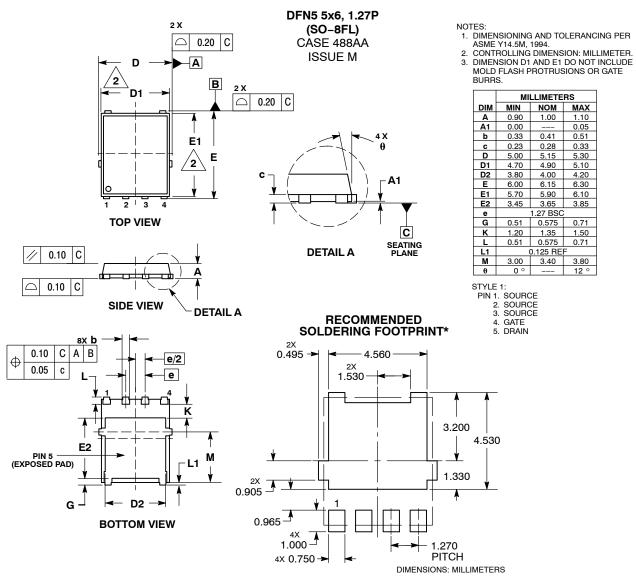
Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMFS5C612NLT1G	5C612L	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS5C612NLWFT1G	612LWF	DFN5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS5C612NLT3G	5C612L	DFN5 (Pb–Free)	5000 / Tape & Reel
NVMFS5C612NLWFT3G	612LWF	DFN5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel
NVMFS5C612NLAFT1G	5C612L	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS5C612NLWFAFT1G	612LWF	DFN5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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